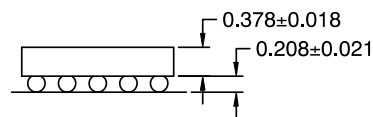
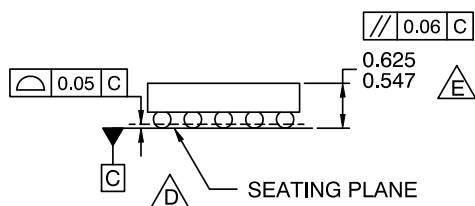
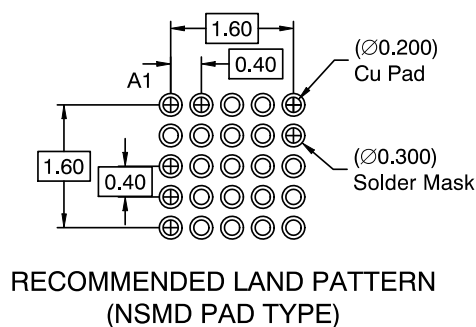
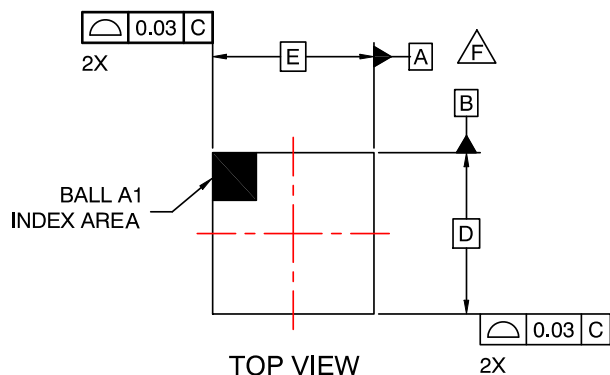
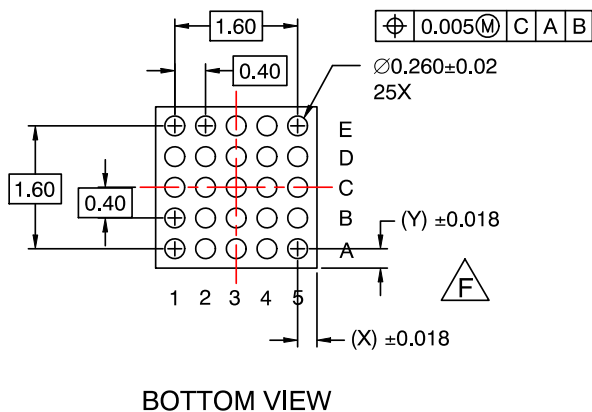


WLCSP25 2.05x2.05x0.586
CASE 567SP
ISSUE O




DATE 30 NOV 2016



SIDE VIEWS



NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASMEY14.5M, 1994.
-  D. DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
-  E. PACKAGE NOMINAL HEIGHT IS 586 MICRONS ± 39 MICRONS (547–625 MICRONS).
-  F. FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.

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DESCRIPTION:	WLCSP25 2.05x2.05x0.586	PAGE 1 OF 1

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